

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

Assignment ID: PATI715948

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HOYA Corporation	12/24/2024
RECEIVING PARTY DATA	
Company Name:	HOYA Medical Singapore Pte. Ltd.
Street Address:	10 Biopolis Road
Internal Address:	#04-01
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	138670
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	7985197
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3109891497
Email:	cslavin@hsh-iplaw.com
Correspondent Name:	Craig A Slavin
Address Line 1:	PO Box 341689
Address Line 4:	Austin, TEXAS 78734
ATTORNEY DOCKET NUMBER:	0181-167
NAME OF SUBMITTER:	Craig Slavin
SIGNATURE:	Craig Slavin
DATE SIGNED:	12/24/2024
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, HOYA Corporation ("ASSIGNOR") is a Japanese corporation, located at 6-10-1, Nishi-Shinjuku, Shinjuku-ku, Tokyo 1608347 Japan;

WHEREAS, HOYA Medical Singapore Pte. Ltd. ("ASSIGNEE") is a Singapore private limited company, located at 10 Biopolis Road, #04-01, Singapore 138670;

WHEREAS, ASSIGNOR OWNS fifty percent (50%) of the right, title and interest in and to U.S. Pat. No. 7,985,197 ("50% RIGHT, TITLE AND INTEREST IN THE PATENT");

WHEREAS, ASSIGNEE desires to obtain ASSIGNOR's 50% RIGHT, TITLE AND INTEREST IN THE PATENT;

NOW THEREFORE, for good and valuable considerations paid by ASSIGNEE to ASSIGNOR, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE, its successors and assignees, the 50% RIGHT, TITLE AND INTEREST IN THE PATENT, together with all rights therein provided by applicable law of any jurisdiction worldwide, international conventions and treaties, including, without limitation, all rights or priority, revival, extension, renewal therein, all rights of enforcement, defenses and protection of interests therein, and the right to sue and collect damages for past, present and future infringement thereof in the sole name of ASSIGNEE, its successors and its assigns, the aforesaid transferred rights, title and interests to be held and enjoyed by ASSIGNEE, its successors, legal representatives and assigns as fully and entirely as the same would have been held and enjoyed by the respective ASSIGNOR had this assignment not been made.

ASSIGNEE hereby accepts the assignment of the 50% RIGHT, TITLE AND INTEREST IN THE PATENT from ASSIGNOR to ASSIGNEE.

ASSIGNOR agrees for itself and its successors, legal representatives and assigns, without further compensation, to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the ASSIGNEE may reasonably request to effectuate fully this assignment.

ASSIGNOR and ASSIGNEE have caused this Assignment to be executed by their duly authorized officers.

HOYA Corporation

By:

池西 美和
Miho Ikenishi
Leader Corporate IP

Date:

December 24, 2024

HOYA Medical Singapore Pte. Ltd.

By:

Brian J. Wong
Brian Wong
Director Intellectual Property

Date:

December 23, 2024

PATENT

RECORDED: 12/24/2024

REEL: 069768 FRAME: 0714